

N800B

Low-Outgassing Non-Silicone Thermal Pad

LiPOLY N800B is a silicone-free thermal interface material based on a non-silicone resin system. It contains no low-molecular-weight siloxane volatiles and features low outgassing characteristics, eliminating concerns of contamination and electrical contact issues. N800B complies with ASTM E595 requirements, making it ideal for applications demanding high cleanliness and reliability. With excellent flexibility, high thermal conductivity, low compression force, and high compressibility, N800B minimizes mechanical stress on components while maintaining low thermal resistance and outstanding heat dissipation performance.

FEATURES

- / Thermal conductivity:13.0 W/m·K
- / It's made by non-silicone resin materials
- / Low contact thermal resistance
- / With electrical insulation
- / Outstanding thermal conductivity
- / Applicable to optical and sensitive electric components

TYPICAL APPLICATION

- / HDDS
- / Optical appliance
- / 5G base station & infrastructure
- / EV electric vehicle

SPECIFICATIONS

- / Sheet form
- / Die-cut parts



TYPICAL PROPERTIES

PROPERTY	N800B	UNIT	TEST METHOD
Color	Gray	-	Visual
Surface tack 2-side/1-side	2	-	-
Thickness	Customized	mm	ASTM D374
Density	3.3	g/cm ³	ASTM D792
Hardness	50	Shore OO	ASTM D2240
Application temperature	-60~130	°C	-
Low molecular Siloxane (D3 to D20 total)	N.D	%	Gas Chromatography
Total Mass Loss (TML)	≤ 1.0	%	ASTM E595
Collected Volatile Condensable Materials (CVCN)	≤ 0.1	%	ASTM E595
Water Vapor Regained	≤ 0.02	%	ASTM E595
ROHS & REACH	Compliant	-	-

COMPRESSION@1.0mm

Deflection @10 psi	12	%	ASTM D5470 modify
Deflection @20 psi	32	%	ASTM D5470 modify
Deflection @30 psi	63	%	ASTM D5470 modify

ELECTRICAL

Dielectric breakdown	8	KV/mm	ASTM D149
Surface resistivity	>10 ¹¹	Ohm	ASTM D257
Volume resistivity	>10 ¹⁰	Ohm-m	ASTM D257

THERMAL

Thermal conductivity	13.0	W/m·K	ASTM D5470
Thermal impedance@10 psi	0.183	°C-in ² / W	ASTM D5470
Thermal impedance@20 psi	0.131	°C-in ² / W	ASTM D5470
Thermal impedance@30 psi	0.074	°C-in ² / W	ASTM D5470

The chemical formula indicates that if Cyclic polydimethylsiloxane (HO-[Si(CH₃)₂O]_n-H) is non-reaction, it's volatile anytime and everywhere. For example, when the electric products which has been put in a confined space, the volatile of low-molecular-weight siloxanes will makes the electric products uncontacted.

Thermal Impedance vs. Pressure vs. Deflection

